# Dual SPST Analog Switch, Low Voltage, Single Supply

The NLAS323 is a dual SPST (Single Pole, Single Throw) switch, similar to 1/2 a standard 4066. The device permits the independent selection of 2 analog/digital signals. Available in the US8 package.

The use of advanced 0.6 micron CMOS process, improves the  $R_{\rm ON}$  resistance considerably compared to older higher voltage technologies.

- On Resistance is 20 Ω Typical at 5.0 V
- Matching is  $< 1.0 \Omega$  Between Sections
- 2.0 to 6.0 V Operating Range
- Ultra Low < 5.0 pC Charge Injection
- Ultra Low Leakage < 1.0 nA at 5.0 V, 25 C
- Wide Bandwidth > 200 MHz, -3.0 dB
- 2000 V ESD (Human Body Model)
- Ron Flatness  $\pm 6.0 \Omega$  at 5.0 V
- US8 Package
- Independent, Positive Enable
- Pb–Free Package is Available\*



# ON Semiconductor®

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MARKING

DIAGRAM

A4 = Device Code D = Date Code



Figure 1. Pinout

	PINAS	
٦	1	NO1
	2	COM1
	3	IN2
	4	GND
	5	NO2
	6	COM2
	7	IN1
	8	V <sub>CC</sub>

#### FUNCTION TABLE

On/Off Enable Input	State of Analog Switch
L	Off
н	On

## **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

### MAXIMUM RATINGS

Symbol		Parameter	Value	Unit
V <sub>CC</sub>	DC Supply Voltage		-0.5 to +7.0	V
VI	DC Input Voltage		-0.5 to +7.0	V
Vo	DC Output Voltage		-0.5 to +7.0	V
I <sub>IK</sub>	DC Input Diode Current	V <sub>I</sub> < GND	-50	mA
I <sub>OK</sub>	DC Output Diode Current	V <sub>O</sub> < GND	-50	mA
I <sub>O</sub>	DC Output Sink Current		±50	mA
I <sub>CC</sub>	DC Supply Current per Supply P	in	±100	mA
I <sub>GND</sub>	DC Ground Current per Ground I	Pin	±100	mA
T <sub>STG</sub>	Storage Temperature Range		-65 to +150	°C
ΤL	Lead Temperature, 1 mm from C	ase for 10 Seconds	260	°C
TJ	Junction Temperature under Bias	5	+ 150	°C
$\theta_{JA}$	Thermal Resistance	(Note 1)	250	°C/W
PD	Power Dissipation in Still Air at 8	5°C	250	mW
MSL	Moisture Sensitivity		Level 1	
F <sub>R</sub>	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V–0 @ 0.125 in	
V <sub>ESD</sub>	ESD Withstand Voltage	Human Body Model (Note 2) Machine Model (Note 3) Charged Device Model (Note 4)	> 2000 > 150 N/A	V

Maximum Ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum-rated conditions is not implied. Functional operation should be restricted to the Recommended Operating Conditions. ) m/n=b/=1 inch, 2=ounce copper trac i w

Measured with minimum pad spacing on an FR4 pound, using '
 Tested to EIA/JE SD22 - 4.114 - A
 Tested to EIA/JESLI22 - A.15 - A

4. Tested to JESD22-C10

## **RECOMMENDED OPERATING CONDITIONS**

Symbol	Characteristics	Min	Max	Unit	
V <sub>CC</sub>	Positive DC Supply Voltage		2.0	5.5	V
V <sub>IN</sub>	Digital Input Voltage (Enable)	GND	5.5	V	
V <sub>IO</sub>	Static or Dynamic Voltage Across an Off Switch	GND	V <sub>CC</sub>	V	
V <sub>IS</sub>	Analog Input Voltage (NO, COM)	GND	V <sub>CC</sub>	V	
T <sub>A</sub>	Operating Temperature Range, All Package Types	-55	+125	°C	
t <sub>r</sub> , t <sub>f</sub>	Input Rise or Fall Time, V <sub>cc</sub> (Enable Input) V <sub>cc</sub>	= 3.3 V <u>+</u> 0.3 V = 5.0 V <u>+</u> 0.5 V	0 0	100 20	ns/V

#### **DEVICE JUNCTION TEMPERATURE VERSUS TIME TO 0.1% BOND FAILURES**

Junction Temperature °C	Time, Hours	Time, Years
80	1,032,200	117.8
90	419,300	47.9
100	178,700	20.4
110	79,600	9.4
120	37,000	4.2
130	17,800	2.0
140	8,900	1.0



bw.

Figure 2. Failure Rate vs. Time Junction Temperature

# DC CHARACTERISTICS – Digital Section (Voltages Referenced to GND)

				Guaranteed Max Limit			
Symbol	Parameter	Condition	v <sub>cc</sub>	–55 to 25°C	<85°C	<125°C	Unit
V <sub>IH</sub>	Minimum High-Level Input Voltage, Enable Inputs		2.0 3.0 4.5 5.5	1.5 2.1 3.15 3.85	1.5 2.1 3.15 3.85	1.5 2.1 3.15 3.85	V
VIL	Maximum Low-Level Input Voltage, Enable Inputs		2.0 3.0 4.5 5.5	0.5 0.9 1.35 1.65	0.5 0.9 1.35 1.65	0.5 0.9 1.35 1.65	V
I <sub>IN</sub>	Maximum Input Leakage Current, Enable Inputs	$V_{IN} = 5.5 V \text{ or GND}$	0 V to 5.5 V	<u>+</u> 0.1	<u>+</u> 1.0	<u>+</u> 1.0	μΑ
Icc	Maximum Quiescent Sup- ply Current (per package)	Enable and VIS = $V_{CC}$ or GND	5.5	1.0	1.0	2.0	μΑ

# DC ELECTRICAL CHARACTERISTICS – Analog Section

				Guaranteed Max Limit		imit	
Symbol	Parameter	Condition	V <sub>CC</sub>	–55 to 25°C	<85°C	<125°C	Unit
R <sub>ON</sub>	Maximum On Resistance (Figures 8 – 12)	$V_{IN} = V_{IH}$ $V_{IS} = V_{CC} \text{ to GND}$ $I_{IS}I = \le 10.0 \text{mA}$	3.0 4.5 5.5	45 30 25	50 35 30	55 40 35	Ω
R <sub>FLAT(ON)</sub>	On Resistance Flatness	$V_{IN} = V_{IH}$ $I_{IS}I = \le 10.0 \text{ mA}$ $V_{IS} = 1 \text{ V}, 2 \text{ V}, 3.5 \text{ V}$	4.5	4.0	4.0	5.0	Ω
I <sub>NO(OFF)</sub>	Off Leakage Current, Pin 2 (Figure 3)	V <sub>IN</sub> = V <sub>II</sub> V <sub>NC</sub> = 1.0 V, V <sub>COM</sub> = 4.5 / or V <sub>COM</sub> = 1.1 V, nd V <sub>L</sub> 0 4 5 V	5.5	1.0		100	nA
ICOM(OFF)	Off Leakage Current, Pin 1 (Figure 3)	V <sub>IN</sub> = V <sub>IL</sub> V <sub>NO</sub> = 4.5 V or 1.0 V V <sub>COM</sub> = 1.0 V or 4.5 V	5.5	1.0	10	100	nA

### AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 3.0 \text{ ns}$ )

				Guaranteed Max Limit									
			V <sub>CC</sub>	-5	5 to 25	3°C		<85°C		•	<125°C	;	
Symbol	Parameter	Test Conditions	(V)	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
t <sub>ON</sub>	Turn-On Time	$R_L$ = 300 $\Omega$ , $C_L$ = 35 pF (Figures 4, 5, and 13)	2.0 3.0 4.5 5.5		7.0 5.0 4.5 4.5	14 10 9.0 9.0			16 12 11 11			16 12 11 11	ns
toff	Turn-Off Time	$R_L$ = 300 $\Omega$ , $C_L$ = 35 pF (Figures 4, 5, and 13)	2.0 3.0 4.5 5.5		11.0 7.0 5.0 5.0	22 14 10 10			24 16 12 12			24 16 12 12	ns

		Typical @ 25, VCC = 5.0 V	
C <sub>IN</sub>	Maximum Input Capacitance, Select Input	8.0	pF
C <sub>NO or</sub> C <sub>NC</sub>	Analog I/O (switch off)	10	
C <sub>COM(OFF)</sub>	Common I/O (switch off)	10	
C <sub>COM(ON)</sub>	Feedthrough (switch on)	20	

ADDITIONAL APPLICATION CHARACTERISTICS (Voltages Referenced to GND Unless Noted)
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			V <sub>CC</sub>	Limit	
Symbol	Parameter	Condition	v	25°C	Unit
BW	Maximum On–Channel –3dB Bandwidth or Minimum Frequency Response	$V_{IS} = 0 \text{ dBm}$ $V_{IS}$ centered between $V_{CC}$ and GND (Figures 6 and 14)	3.0 4.5 5.5	190 200 220	MHz
V <sub>ONL</sub>	Maximum Feedthrough On Loss	$V_{IS} = 0 \text{ dBm } @ 10 \text{ kHz}$ $V_{IS}$ centered between $V_{CC}$ and GND (Figure 6)	3.0 4.5 5.5	-2 -2 -2	dB
V <sub>ISO</sub>	Off-Channel Isolation	f = 100 kHz; $V_{IS}$ = 1.0 V RMS V <sub>IS</sub> centered between V <sub>CC</sub> and GND (Figures 6 and 15)	3.0 4.5 5.5	-93	dB
Q	Charge Injection Enable Input to Common I/O	$ \begin{array}{l} V_{IS} = V_{CC \ to} \ GND, \ F_{IS} = 20 \ kHz \\ t_r = t_f = 3.0 \ ns \\ R_{IS} = 0 \ \Omega, \ C_L = 1000 \ pF \\ Q = C_L ^* \ \Delta V_{OUT} \\ (Figures 6 \ and 16) \end{array} $	3.0 5.5	1.5 3.0	pC
THD	Total Harmonic Distortion THD + Noise	$\label{eq:FIS} \begin{array}{l} F_{\text{IS}} = 20 \; \text{Hz to 1 MHz}, \; R_{\text{L}} = Rgen = 600 \; \Omega, \; C_{\text{L}} = 50 \; \text{pF} \\ V_{\text{IS}} = 3.0 \; V_{\text{PP}} \; \text{sine wave} \\ V_{\text{IS}} = 5.0 \; V_{\text{PP}} \; \text{sine wave} \\ \end{array}$ (Figure 17)	3.3 5.5	0.3 0.15	%



Figure 3. Switch Leakage vs. Temperature







Figure 5. t<sub>ON</sub>/t<sub>OFF</sub>



Channel switch control/s test socket is normalized. Off isolation is measured across an off channel. On loss is the bandwidth of an On switch.  $V_{ISO}$ , Bandwidth and  $V_{ONL}$  are independent of the input signal direction.

$$\begin{split} & \mathsf{V}_{\mathsf{ISO}} = \mathsf{Off \ Channel \ Isolation} = 20 \ \mathsf{Log} \ \left(\frac{\mathsf{V}\mathsf{OUT}}{\mathsf{VIN}}\right) \ \mathsf{for} \ \mathsf{V}_{\mathsf{IN}} \ \mathsf{at} \ 100 \ \mathsf{kHz} \\ & \mathsf{V}_{\mathsf{ONL}} = \mathsf{On \ Channel \ Loss} = 20 \ \mathsf{Log} \ \left(\frac{\mathsf{V}\mathsf{OUT}}{\mathsf{VIN}}\right) \ \mathsf{for} \ \mathsf{V}_{\mathsf{IN}} \ \mathsf{at} \ 100 \ \mathsf{kHz} \ \mathsf{to} \ 50 \ \mathsf{MHz} \end{split}$$

Bandwidth (BW) = the frequency 3.0 dB below  $V_{ONL}$ 

Figure 6. Off Channel Isolation/On Channel Loss (BW)/Crosstalk (On Channel to Off Channel)/V<sub>ONL</sub>









Figure 16. Charge Injection vs. V<sub>COM</sub>

FREQUENCY (Hz)
Figure 17. THD vs. Frequency

### **DEVICE ORDERING INFORMATION**

		Device Nome	enclature			
Device Order Number	Circuit Indicator	Technology	Device Function	Package Suffix	Package	Shipping <sup>†</sup>
NLAS323US	NL	AS	323	US	US8	178 mm (7″) 3000 / Tape & Reel
NLAS323USG	NL	AS	323	US	US8 (Pb–Free)	178 mm (7″) 3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

### PACKAGE DIMENSIONS

US8 US SUFFIX CASE 493–02 ISSUE A



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